

## COMBINED DECLARATION AND POWER OF ATTORNEY

CP

(宣誓書及び委任状)

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name, I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

"SEMICONDUCTOR DEVICE AND METHOD FOR MANUFACTURING THE SAME"

the specification of which: (check	one) X is attached he	reto.		
	was filed on _			
	as Application	Serial No.		
	• •	ided on		
		(if applicable)		
I hereby state that I have revising the claims, as amended, by any I acknowledge the duty to disto me which is material to patental I hereby claim foreign prior tion(s) for patent or inventor's certificate or are the United States of America filed to application(s) on which priority is of	amendment referred to aclose to the United State of the United State of the United State of the English and English and the English PCT international approxime on the same subject to the same of the same subject in the same su	o above.  es Patent and Trademark O  Title 37, Code of Federal  35, United States Code, § I  ave also identified below ar  plication(s) designating at le	ffice all info Regulations 119 of any f ny foreign ap east one cou	ormation known , § 1.56. foreign applica- pplication(s) for intry other than
Prior Foreign Application(s)			Priority C	laimed
07-319482 (Number)	Japan (Country)	14 November, 1 (Day/Month/Year Filed)	995 <u>×</u>	No No
(Number)	(Country)	(Day/Month/Year Filed)	Yes	No.
(Number)	(Country)	(Day/Month/Year Filed)	Yes	No.
I hereby claim the benefit ur international application(s) designa subject matter of each of the claim manner provided by the first parage the United States Patent and Trad defined in Title 37, Code of Federal application and the national or PC (Application Serial No.)	ting the United States of this application is raph of Title 35, United emark Office all inform I Regulations, § 1.56 whice	of America that is/are listed not disclosed in that/those States Code § 112, I acknow nation known to me to be the became available between	d below and prior appli ledge the du material to n the filing o	l, insofar as the cation(s) in the ity to discolse to patentability as
(Application Serial No.)	(Filing Date)	(Status) (patented, pending.	(Status) (patented, pending, abandoned)	

I hereby appoint Elliott I. Pollock, RN (Registration No.)

16,906; George Vande Sande, RN 17,276; Robert R. Priddy,
RN 20,169; Burton A. Amernick, RN 24,852; Stanley B. Green,
RN 24,351; Richard Wiener, RN 18,741; Townsend M. Belser, Jr.,
RN 22,956; Morris Liss, RN 24,210; Martin Abramson, RN 25,787;
George Pettit, RN 27,369; Dean E. Carlson, RN 18,537;
Louis Woo, RN 31,730; and Elzbieta Chlopecka, RN 32,767,
my attorneys with full power of substitution and revocation, to
prosecute this application and to transact all business in the
Patent and Trademark Office connected therewith.

Please direct all communications to the following address: POLLOCK, VANDE SANDE & PRIDDY, P. O. Box 19088, Washington, D. C. 20036, U. S. A.

Telephone: 331-7111

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further, that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

宣誓 日		発明者フルネームサイ	ソ	氏名	タイプ欄
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